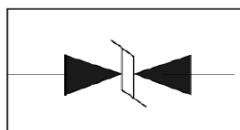



**DFN1006**

**Features**

550Watts peak pulse power( $t_p=8/20\mu s$ )

Low clamping voltage

Low leakage current

Glass passivated junction

Bidirectional configurations

IEC 61000-4-2 ±30KV contact ± 30KV air

Halogen free and RoHS compliant

**Mechanical Data**

CASE: DFN1006 Molded Plastic

Molding compound flammability rating: UL 94V-0

Mounting Position: Any

**Making Code & Ordering information**


Ordercode	Package	Base qty	Deliverymode
PDF2V07C45	DFN1006	10000	Tape and reel

**Maximum Ratings & Thermal Characteristics**

(Ratings at 25°C ambient temperature unless otherwise specified.)

Rating	Symbol	Value	Units
Peak Pulse Power ( $t_p = 8/20\mu s$ )	$P_{PP}$	550	Watts
Peak Pulse Current ( $t_p = 8/20\mu s$ )(note1)	$I_{pp}$	50	A
ESD per IEC 61000-4-2 (Air) ESD per IEC 61000-4-2(Contact)	$V_{ESD}$	30 30	kV
Lead Soldering Temperature	$T_L$	260(10seconds)	°C
Junction Temperature	$T_J$	-55 to + 125	°C
Storage Temperature	$T_{stg}$	-55 to + 125	°C

**Electrical Characteristics**

(Ratings at 25°C ambient temperature unless otherwise specified).

Parameter	Symbol	Conditions	Min	Typical	Max	Units
Reverse Stand-Off Voltage	$V_{RWM}$				7.0	V
Reverse Breakdown Voltage	$V_{BR}$	$I_T=1mA$	7.2	7.5		V
Reverse Leakage Current	$I_R$	$V_{RWM}=7V, T=25^\circ C$		0.1	0.5	uA
Clamping Voltage	$V_C$	$I_{PP}=50A, t_p=8/20\mu s$		11		V
Junction Capacitance	$C_J$	$V_R = 0V, f = 1MHz$		140		pF

## Ratings and Characteristic Curves

(Ratings at 25°C ambient temperature unless otherwise specified).

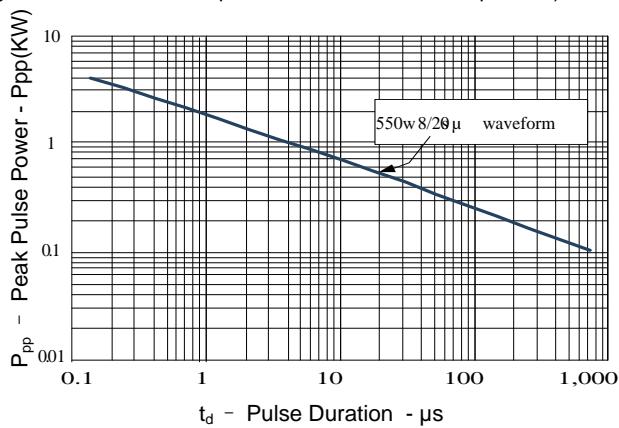


Figure 1: Peak Pulse Power vs. Pulse Time

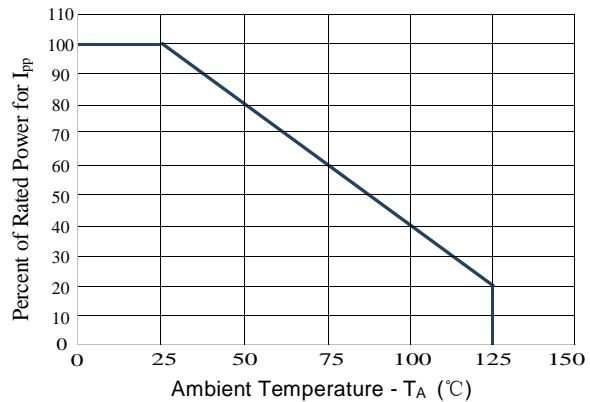


Figure 2: Power Derating Curve

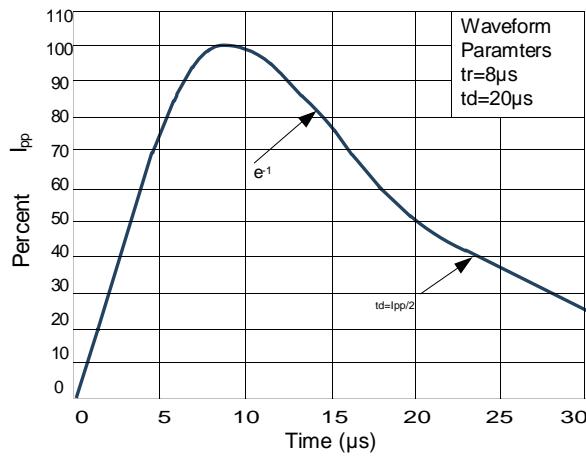


Fig.3 Pulse Waveform-8/20μs

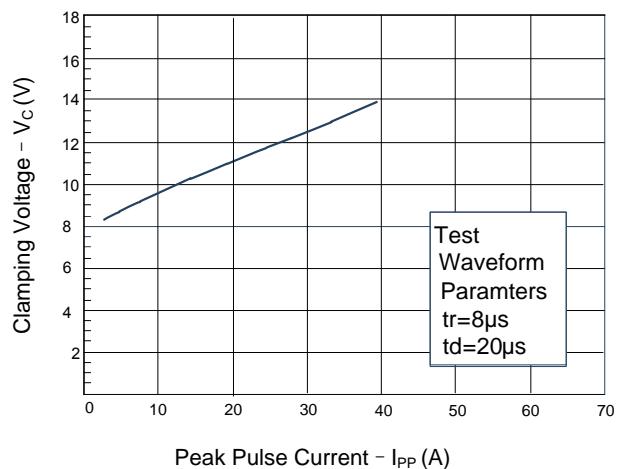


Fig.4 Pulse Waveform-ESD(IEC61000-4-2)

## Package Outline Dimensions: DFN1006

